

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6424975

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
DOO SEEK PARK	11/18/2020
EUN SANG RYU	11/18/2020
HYEONG SEOP KIM	11/18/2020
MOON SEOK HWANG	11/18/2020
GI WOO LEE	11/18/2020
HYUNG KI YOON	11/18/2020
KWANG HYUN CHO	11/18/2020
JAE WOO SUNG	11/18/2020
SOON SHIK KIM	11/18/2020
YOUNG SIK KIM	11/18/2020

RECEIVING PARTY DATA

Name:	HYUNDAI MOTOR COMPANY
Street Address:	12, HEOLLEUNG-RO, SEOCHO-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	06797
Name:	KIA MOTORS CORPORATION
Street Address:	12, HEOLLEUNG-RO, SEOCHO-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	06797
Name:	SHINWOOSHIN CO., LTD.
Street Address:	936-1, GYEONGCHEONG-RO, NAMCHEON-MYEON
Internal Address:	GYEONGSANGBUK-DO
City:	GYEONGSAN-SI
State/Country:	KOREA, REPUBLIC OF
Postal Code:	38695
Name:	HANDS CORPORATION LTD.
Street Address:	50, GAJEONG-RO 37BEON-GIL, SEO-GU
City:	INCHEON

PATENT

State/Country:	KOREA, REPUBLIC OF
Postal Code:	22836
Name:	KWANG SUNG CORPORATION LTD
Street Address:	212-14, NEUNGAN-GIL, SONGSAN-MYEON
Internal Address:	CHUNGCHEONGNAM-DO
City:	DANGJIN-SI
State/Country:	KOREA, REPUBLIC OF
Postal Code:	31711

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17108217

CORRESPONDENCE DATA

Fax Number: (415)442-1001

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 4154421000

Email: peter.roidmaier@morganlewis.com

Correspondent Name: MORGAN, LEWIS & BOCKIUS LLP (SF)

Address Line 1: ONE MARKET, SPEAR STREET TOWER, SUITE 28

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ATTORNEY DOCKET NUMBER:	060943-5581-US
NAME OF SUBMITTER:	PETER F. ROIDMAIER
SIGNATURE:	/Peter F. Roidmaier/
DATE SIGNED:	12/01/2020

Total Attachments: 6

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ASSIGNMENT
(Joint Inventors)

WHEREAS, the undersigned, (1) **PARK, Doo Seek**, resident of 201, 17-8, Tongil-ro 89-gil, Eunpyeong-gu, Seoul, 03328, Republic of Korea, and (2) **RYU, Eun Sang**, resident of 9-102, 324, Dangsang-ro, Seo-gu, Daegu, 41838, Republic of Korea, and (3) **KIM, Hyeong Seop**, resident of 714-1102, 33, Sanboncheon-ro, Gumpo-si, Gyeonggi-do, 15825, Republic of Korea, and (4) **HWANG, Moon Seok**, resident of 201, 12, Boseok-ro 18beon-gil, Seo-gu, Incheon, 22766, Republic of Korea, and (5) **LEE, Gi Woo**, resident of 102-2103, 91, Cheoneul-ro, Susong-gu, Daegu, 42261, Republic of Korea (6) **YOON, Hyung Ki**, resident of 119-406, 105, Gulpo-ro, Bupyeong-gu, Incheon, 21328, Republic of Korea, and (7) **CHO, Kwang Hyun**, resident of 412-1103, 232, Cheongna canal-ro, Seo-gu, Incheon, 22763, Republic of Korea, and (8) **SUNG, Jae Woo**, resident of 302, 7-9, Bongujas-ro 23beon-gil, Siheung-si, Gyeonggi-do, 15056, Republic of Korea, and (9) **KIM, Soon Shik**, resident of 106-607, 25, Gyeongsan-ro, Gyeongsan-si, Gyeongsangbuk-do, 38692, Republic of Korea, and (10) **KIM, Young Sik**, resident of 329-2203, 96, Cheongnahanul-ro, Seo-gu, Incheon, 22747, Republic of Korea (hereinafter termed "Inventors"), respectively, have invented certain new and useful improvements in *DEVICE FOR COUPLING RESONATOR TO VEHICLE WHEEL* and executed therefore an application for Letters Patent of the United States and

- having an oath or declaration executed on even date herewith.
 bearing U.S. Patent Application No. _____ and filed on _____

WHEREAS, **Hyundai Motor Company**, a corporation of the Republic of Korea, having a place of business at 12, Heolleung-ro, Seocho-gu, Seoul, 06797, Republic of Korea, and **Kia Motors Corporation**, a corporation of the Republic of Korea, having a place of business at 12, Heolleung-ro, Seocho-gu, Seoul, 06797, Republic of Korea, and **SHENWOOSHIN CO.,LTD.**, a corporation of the Republic of Korea, having a place of business at 936-1, Gyeongcheong-ro, Namcheon-myeon, Gyeongsan-si, Gyeongsangbuk-do, 38695, Republic of Korea, and **HANDS CORPORATION Ltd.**, a corporation of the Republic of Korea, having a place of business at 50, Gajeong-ro 37beon-gil, Seo-gu, Incheon, 22836, Republic of Korea, **KWANG SUNG CORPORATION LTD.**, a corporation of the Republic of Korea, having a place of business at 212-14, Neungan-gil, Songsan-myeon, Dangjin-si, Chungcheongnam-do, 31711, Republic of Korea (hereinafter termed "Assignee"), is desirous of acquiring the entire right, title and interest of said Inventors in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered jointly or severally by said Inventors (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventors to have been received in full from said Assignee:

I. Said Inventors do hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply for foreign patents on said

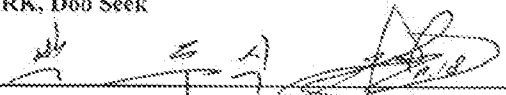
invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications; and (d) in and to each and every reissue or extensions of any of said patents.

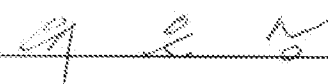
2. Said Inventors do hereby jointly and severally covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventors shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventors in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventors, their respective heirs, legal representatives and assigns.

4. Said Inventors do hereby jointly and severally warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Inventors have executed and delivered this instrument to said Assignee as follows.

(1) PARK, Doo Seek
Date: November 18, 2020 By: 

(2) RYU, Eun Sang
Date: November 18, 2020 By: 

PATENT

Attorney Docket No. _____

(3) **KIM, Hyeong Seop**

Date: November 18, 2020

By: _____

(4) **HWANG, Moon Seok**

Date: November 18, 2020

By: _____

(5) **LEE, Gi Woo**

Date: November 18, 2020

By:  _____

(6) **YOON, Hyung Ki**

Date: November 18, 2020

By: _____

(7) **CHO, Kwang Hyun**

Date: November 18, 2020

By: _____

(8) **SUNG, Jae Woo**

Date: November 18, 2020

By: _____

(9) **KIM, Soon Shik**

Date: November 18, 2020

By:  _____

(10) **KIM, Young Sik**

Date: November 18, 2020

By: _____

PATENT

Attorney Docket No. _____

(3) KIM, Hyeong Seop

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By: _____

(6) YOON, Hyung Ki

Date: November 18, 2020

By: 


(7) CHO, Kwang Hyun

Date: November 18, 2020

By: _____

(8) SUNG, Jae Woo

Date: November 18, 2020

By: 

(9) KIM, Soon Shik

Date: November 18, 2020

By: _____

(10) KIM, Young Sik

Date: November 18, 2020

By: _____

PATENT

Attorney Docket No. _____

(3) KIM, Hyeong Seop

Date: November 18, 2020

By: _____

(4) HWANG, Moon Seok

Date: November 18, 2020

By: 황문석

(5) LEE, Gi Woo

Date: November 18, 2020

By: _____

(6) YOON, Hyung Ki

Date: November 18, 2020

By: _____

(7) CHO, Kwang Hyun

Date: November 18, 2020

By: 최광현

(8) SUNG, Jae Woo

Date: November 18, 2020

By: _____

(9) KIM, Seon Shik

Date: November 18, 2020

By: _____

(10) KIM, Young Sik

Date: November 18, 2020

By: 김영식